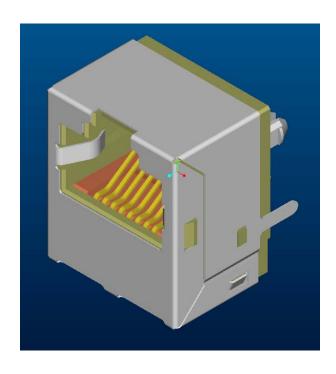


□東莞睦永電子五金廠

PRODUCT SPECIFICATION



ACRON P/N:GDI22-N3-080K300

育鼎精密工業股份有限公司 ACRON PRECISION INDUSTRIAL CO., LTD

桃園縣八德市廣德里新興路 55 號

No.55, SinSing Road., Bade City, Taoyuan County 334, Taiwan(R.O.C)

TEL: 886-3-3629889 FAX: 886-3-3664917

□東莞育鼎電子五金廠

東莞愷興電子科技電子有限公司

(AMMI)			(ACRON)			(NUCONN)		
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1.0 SCOPE

This Product Specification covers the performance requirements for Low profile vertical RJ45 10/100 Base-T connector series.

2.0 PRODUCT DESCRIPTION

2.1 PRODUCT NAME AND SERIES NUMBER(S)

Low profile vertical RJ45 10/100 BASE-T series. Nuconn part No:GDI22-N3-080K300,

2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See appropriate sales drawings for details on dimensions, materials, plating and markings.

2.3 SAFETY AGENCY APPROVALS

See appropriate sales drawings

2.4 PRODUCT WEIGHT

The product weight is 4.5g

2.5 PRODUCING PLANT FACTORY AND ADDRESS

Producing plant factory: Nuconn Industry CORP

Coil plant factory: DongGuan Nuconn Industry CORP.or MinXin Electronic CORP

or Vetak Electronic CORP.

DongGuan Nuconn Industry CORP. Address:

Nr.32,RongFu Rd.,3rd Industrial District,ShangSha Village,,ChangeAn Town,DonGuan City, Guang Dong,

MinXin Electronic CORP.Address:

Qianwei City industrial park, SiChuan

Vetak Electronic CORP. Address

XinZhai Village, Sansui city, GuiZhou,

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

Please refer to the Sales Drawings, and other sections of this Specification for specific references to applicable documents and specifications. In cases where the Product Specification differs from the Sales Drawings, the Sales Drawing will take precedence

3.1 TURNS RATIO:

(P1-P2): (J1-J2): 1CT:1CT±5% (P4-P5): (J3-J6): 1CT:1CT±5%

3.2 INDUCTANCE:

(P1-P2): 360~580uH. @0.1V,100KHz, 8mA DC Bias (P4-P5): 360~580uH. @0.1V,100KHz, 8mA DC Bias

3.3 LEAKAGE INDUCTANCE:

P1-P2(Short J1-J2) : 0.3 uH MAX, @1MHz P4-P5(Short J3-J6): 0.3 uH MAX, @1MHz

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3.4 INTER-WINDING CAPACITANCE:

(P1,P2,P3) TO (J1,J2):35pf MAX, @1MHz (P4,P5,P6) TO (J3,J6):35pf MAX, @1MHz

3.5 DC RESISTANCE:

(J1-J2) and (J3-J6): 1.2 ohms MAX

3.6 RETURN LOSS:

(P1-P2) (P4-P5) @LOAD 100 ohm

1~30MHz:-18dB MIN 30~ 60MHz: -16dB MIN 60~ 80MHz: -12dB MIN

3.7 INSERTION LOSS

(J1,J2) TO (P1,P2) and (J3,J6) TO (P4,P5): 1~100Mhz :-1.0dB Max

3.8. CROSS TALK:

TX to RX.:1-100 MHz: -30dB MIN

3.9. COMMON TO COMMON MODE REJECTION:

(J1,J2) to (P1,P2) and (J3,J6) to (P4,P5): 1~100Mhz:-35dB MIN

3.10. HI-POT:

(J1,J2) TO (P1,P2,P3): 1500 VAC or 2250VDC 60SEC@60Hz (J3,J6) TO (P4,P5,P6): 1500 VAC or 2250VDC 60SEC@60Hz

3.11.RATING CURRENT:750mA MAX

3.12 DIFFERENTIAL VOLTAGE vp-p:10V MAX.

3.13 TEMPERATURE

Operating Temperature Range: 0°C to +85°C

Storage Temperature Range: - 40°C to + 85°C

5.0 PERFORMANCE

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Item	Test Items	Requirement	Procedures
1	Examination of Product	Meets requirements of product drawing. No physical damage.	Visual, dimensional and functional per applicable quality inspection plan.

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	Electrical Requirements									
2	LOW Level Contact Resistance	30 mΩ max initial $\Delta R = 30$ mΩ max final	Mate subject connector with compatible connector. EIA-364-23B							
3	Insulation Resistance	1000 M Ω min initial 50 M Ω min final	Apply 100±10% Volts DC between adjacent contacts of mated connectors for one minute. EIA-364-21							
4	Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max	For mated specimens, 2250VDC or 1500VAC 60 sec,between connected RJ interface contacts and all PCB tails connected together with shield. 1 milliamp ere cutoff current, 500 Volts per second maximum ramp. EIA-364-20							

		Mechanical Requirer	nents		
5	5 Mating and Un- mating Forces	Insertion Force:22N max Unlatched Withdrawal Force: 22N max	Measure force necessary to mate and un-mate connectors using the free floating fixtures at rate of 25mm/min.		
		Latched Withdrawal Force: 89N min	EIA-364-05B		
6	Solder ability	Wetting must occur over at least 95% of the solder immersion surface	Solder:SN/3.0Ag/0.5Cu,Flux:ROSIN 25%,IPA75%.High Temp Storage:150°ℂ 1 hour, PCT: 105°ℂ 100% 1.22*105Pa 4 hours. Solder 240°ℂ±2°ℂ; Immersion depth 2mm; Immersion time 3S		
7	Terminal Strength	Appearance meet requirement	Gravitation 500g , Winding 90 angle 2-3sec		
8	KOJIRI Strength	Appearance meet requirement	Left: 100N, push 15sec Right: 100N, push 15sec Up: 100N, push 15sec Down: 100N, push 15se		

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9	Solder Joint Strength Test	 (1) The variation must be 50 % ≤ of the initial value (2) After test measured items must be 75 % ≤ of solder (Pb/Sn) item 	(1)Temp Cycle Test Min Temp: -40°C. MAX TEMP:+125°C TIME: Each 30 min. CYCLES:200 (2) Measurement Item: Component with LEAD: Tension Test (EIAJED-4702); Component without LEAD: Bend Test (EIAJED-4702) (3) Measurement cycle: INITIAL,(100) 200 (4) Measurement SMPL: Component with LEAD: 5LEADS≦ Component without LEAD: 5POINTS≦ To calculate Average
10	Physical Shock	No electrical discontinuity greater than 1µsecond. Shall meet visual requirements, and show no physical damages.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. EIA-364-27B
11	Durability	750 cycles with no function damage for RJ-45. Low Level Contact Resistance: ΔR = 30m Ω max final	The sample should be mounted in the tester and fully mated and unmated 300 times per hour at the rate of 25mm/min. EIA-364-09C
12	Random Vibration	No electrical discontinuity greater than 1µsecond. Shall meet visual requirements, and show no physical damages.	The electrical load condition shall be 100mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency which being varied uniformly between the approximate limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. EIA-364-28D

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	Environment Requirements								
13	Thermal Shock (Simulate Non- Operating State)	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to 100 cycles between -40°C and 85°C, 30 minutes duration at both temperature extremes. EIA-364-32C						
14	Humidity- Temperature Cycling	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Mated connectors placed in humidity chamber (Humidity 80-98%, Temperature 20-65°C) for 500 Hrs. EIA-364-31B, Method IV, Except 7a						
15	Temperature Life (Heat Aging)	\triangle R: 30 m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at 85°C for 500 hours. EIA-364-17B, Method A						
16	Temperature Life (Cold Aging)	\triangle R: 30m Ω max (change from initial) & Appearance: no damage	Subject mated connectors to temperature life at-40°C for 500 hours EIA-364-17B, Method A						
17	Salt Spray	\triangle R: $30m\Omega$ max (change from initial) & Appearance: no damage	8hours moving 16hours resting total 24hours 3cycles Atmosphere: salt spray from a 5% solution. Temperature: 35 +1/-2°C EIA 364-26						
18	Damp Heat, Steady State	JIS C 0022 JEC Pub.68 2-3 Ca MIL-STD-202 103B	Test Temp :40±2℃ Relative Humidity:90~95%RH Test time:500Hrs						
19	Change of Temperature	JIS C 0025 JEC Pub.68 2-14 NA MIL-STD-202 102A (Unless otherwise specified, either method 1or method 2. is to be closen)	Metod1						
20	Ammonia	Appearance: no damage	Hydrogen Ion Exponent Index (PH)=10 Test Temperature:15~35℃ Test Time:72±4hrs						

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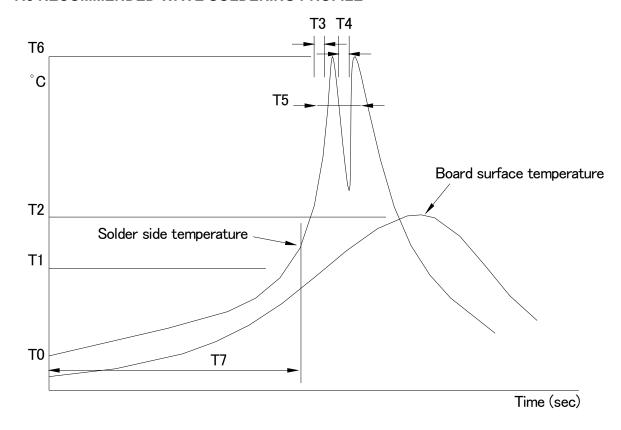


		Electrical and mechanical performance must be satisfactory in specifications	MATERIALS Solder: Sn/99Ag/0.3/Cu0.7(Weight&) If no doubts araise in judgment, it is ok to use another
21	Soldering Heat	2:There must no conspicuous changes in appearance(For example warping, swelling, cracking, indication) 3.The plastic no damage	SOLDER TEST CONDITION 1 : TEST A: Flow Soldering (Partly Heating) 260±3°C 10S≦ 2 : TEST B: Hand Soldering 400°C (Soldering iron tiop) 3S≦

6.0 PACKAGING

Parts shall be packaged to protect against damage during handling, transit and storage. See packaging appropriate drawings

7.0 RECOMMENDED WAVE SOLDERING PROFILE

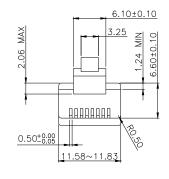


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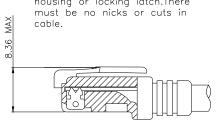


	T0	25~35°C (Room temperature)		
Start temperature	T1	90~120°C		
Pre-heat time	Т7	MAX 180s		
Soldering time(solder side)	Т6	MAX 260+3°C		
Soldering temperature(board surface)	T2	MAX 150°C	cradle use	
Soldering temperature(board surface)	T2	MAX 170°C	cradle no use	
Soldering time	Т3	1st wave 1±0.5s	MAX temperature time	
Soldering time	T4	2nd wave 3±1s	MAX temperature time	
Max temperature arrival time	T7	180~210(MAX) s		
225°C over time	T5	3~15 s		
solder time		two time		

8.0 RECOMMENDED RJ PLUG SPECIFICATION



There must be no damage to housing or locking latch.There must be no nicks or cuts in cable.



0.89 MIN 12.32 MIN .76±0. 2.34 MAX -Locking Latch 1.32 MAX Terminal-All contacts recessed below top of housing and must be at the same height approximately ·Housing \angle Cable -Conductor Wire 5.59 MIN FOLLOW SPECIFICATION: FCC, PART 68, SUBPART F FIGURE 68.500 (C)(2)(i) AND IEC 603-7 FIGURE 23 & 24

FOLLOW SPECIFICATION: FCC, PART 68, SUBPART F FIGURE 68.500 (C)(2)(ii)

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